

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	7129	@ad<="20030915" and (257/382).ccls. or (257/532).ccls. or (257/755).ccls. or (257/763).ccls. or (257/E21.507).ccls. or (257/E21.59).ccls. or (257/E21.593).ccls. or (257/E21.66).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:41
L2	3176	@ad<="20030915" and (438/238).ccls. or (438/586).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:41
L3	123	@ad<="20030915" and 'SRAM' same 'polysilicon layers' and 'cell' and 'peripheral'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:43
L4	123	@ad<="20030915" and 'SRAM' same 'polysilicon layers' and 'cell' and 'peripheral'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:43
S1	9	@ad<="20030915" and 'cell' same 'logic' same 'cell gate oxide' and 'polysilicon'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 16:03
S2	30	@ad<="20030915" and 'SRAM' same 'dual' with 'polysilicon'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 16:40
S3	6963	@ad<="20030915" and (257/382).ccls. or (257/532).ccls. or (257/755).ccls. or (257/763).ccls. or (257/E21.507).ccls. or (257/E21.59).ccls. or (257/E21.593).ccls. or (257/E21.66).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:41
S4	3125	@ad<="20030915" and (438/238).ccls. or (438/586).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:41
S5	1	"6080647".PN.	USPAT; USOCR	OR	ON	2004/12/06 16:19
S6	1	"5866451".PN.	USPAT; USOCR	OR	ON	2004/12/06 16:19
S7	5938	@ad<="20030915" and (438/621).ccls. or (438/655).ccls. or (438/656).ccls. or (438/657).ccls. or (438/253).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 16:29
S8	1	"6294420".PN.	USPAT; USOCR	OR	ON	2004/12/06 16:22

S9	1	"6177340".PN.	USPAT; USOCR	OR	ON	2004/12/06 16:22
S10	2030	@ad<="20030915" and (438/585).ccls. or (438/152).ccls. or (438/594).ccls. or (438/734).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 16:29
S12	159	@ad<="20030915" and 'SRAM' same 'polysilicon layers' and 'cell' and 'logic'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 17:21
S13	122	@ad<="20030915" and 'SRAM' same 'polysilicon layers' and 'cell' and 'peripheral'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 14:42
S14	2188	@ad<="20030915" and (438/253).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 17:03
S15	174	@ad<="20030915" and 'SRAM' same 'first polysilicon' and 'second polysilicon'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 17:22
S16	669	@ad<="20030915" and 'SRAM' and 'first polysilicon' and 'second polysilicon'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 17:22
S17	543	@ad<="20030915" and 'SRAM' and 'first polysilicon' and 'second polysilicon' and 'cell' and 'device'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/06 17:23
S18	304	@ad<="20030915" and 'SRAM' and 'first polysilicon' and 'second polysilicon' and 'cell' same 'device' same 'region'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 08:28
S19	653	@ad<="20030915" and 'SRAM' same 'memory' and 'peripheral' and 'polysilicon layers'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 08:29
S20	301	@ad<="20030915" and 'SRAM' and 'first polysilicon' and 'second polysilicon' and 'memory' same 'device' same 'region'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 08:29

S21	9	@ad<="20030915" and 'SRAM' same 'memory' same 'peripheral' same 'polysilicon layers'	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 08:29
S22	811	@ad<="20030915" and (257/903).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:35
S23	324	@ad<="20030915" and (257/380-381).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:40
S24	138	@ad<="20030915" and (257/385).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:41
S25	260	@ad<="20030915" and (257/756).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:41
S26	501	@ad<="20030915" and (438/647).ccls. or (438/657).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:43
S27	196	@ad<="20030915" and (438/630).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:45